

**Office of the Dean Research and Development
Indian Institute of Engineering Science & Technology (IEST), Shibpur
Howrah-711 103**

Project Code: DRC/DST/CEGESS/CB/007/15-16

**Centre of Excellence for Green Energy & Sensor Systems
Indian Institute of Engineering Science & Technology (IEST), Shibpur
Howrah-711 103**

**Ref.: Advt. No. CGE 1292, published in the "Statesman (All Edition)",
dated 25.09.2017**

Notice Inviting Quotations

Sealed quotations are invited for the supply of

Item 1. FZ Si Wafers.

as per the following technical specification. The technical specification can be downloaded from the website. The document can be also obtained from the Centre of Excellence for Green Energy & Sensor Systems (contact: Dr. Sumita Mukhopadhyay) between 10.30 a.m. and 3.00 p.m. on all working days. The invitation is valid for 14 working days from the date of publication of this notice.

Dean (R & D)

(A. Code DRC-T066/17-18)

SECTION I: TERMS & CONDITIONS

- 1.** The last date of receipt of quotation is valid **for 14 working days** from the date of publication of this notice. Quotations received later will not be entertained under any circumstances.
- 2.** Potential supplier are to submit the quotations in Sealed Cover to the Centre of Excellence for Green Energy & Sensor Systems in the following address:

**Dr. Sumita Mukhopadhyay
CEGESS
IEST, Shibpur
Howrah-711103, India**

- 3.** Item name must be mentioned on cover
- 4.** The price quoted should be inclusive of all Taxes in INR, duties and levies. Inclusion of Tax/Levy at a latter stage will not be accepted. Freight, Insurance charges should be clearly indicated. If GST is chargeable then price quoted should be inclusive of GST in INR.
- 5. Customs Duty & clearance** charges should be include . DSIR & CDEC will be provided by IEST, Shibpur . Total CIP/FOR ,iest,Shibpur price should be quoted
- 6.** Vendor should have proven track record of supply in IEST, IIT, NIT, IISc.
- 7.** Commercial Papers duly signed & must be attached.

SECTION II: TECHNICAL SPECIFICATIONS

Item 1.

FZ Si Wafers.

- Thickness : <300 microns
- Orientation : <100>
- Type : N-Type
- Polishing : Double side polished
- Carrier Lifetime : > 5000 micro seconds

Quantity : 25 Pcs.